

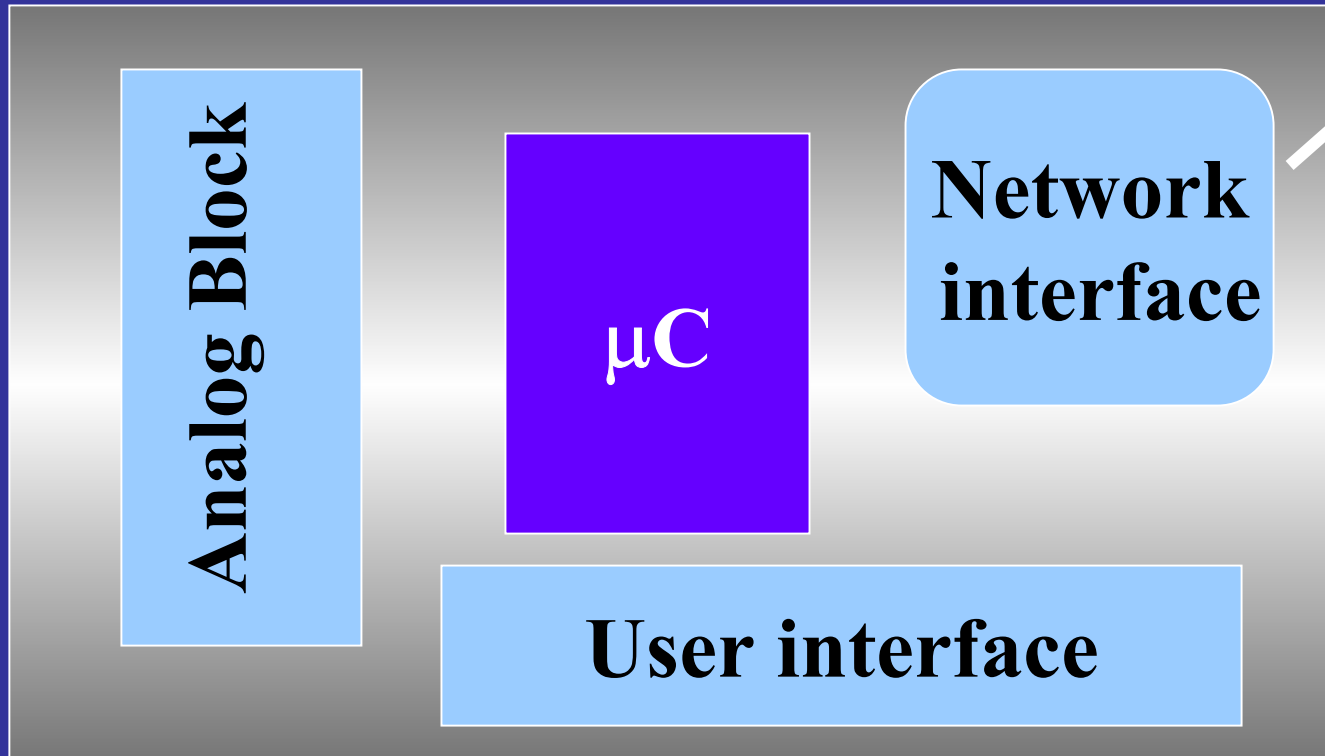
Using μ Cs for EDP

Vivek V.

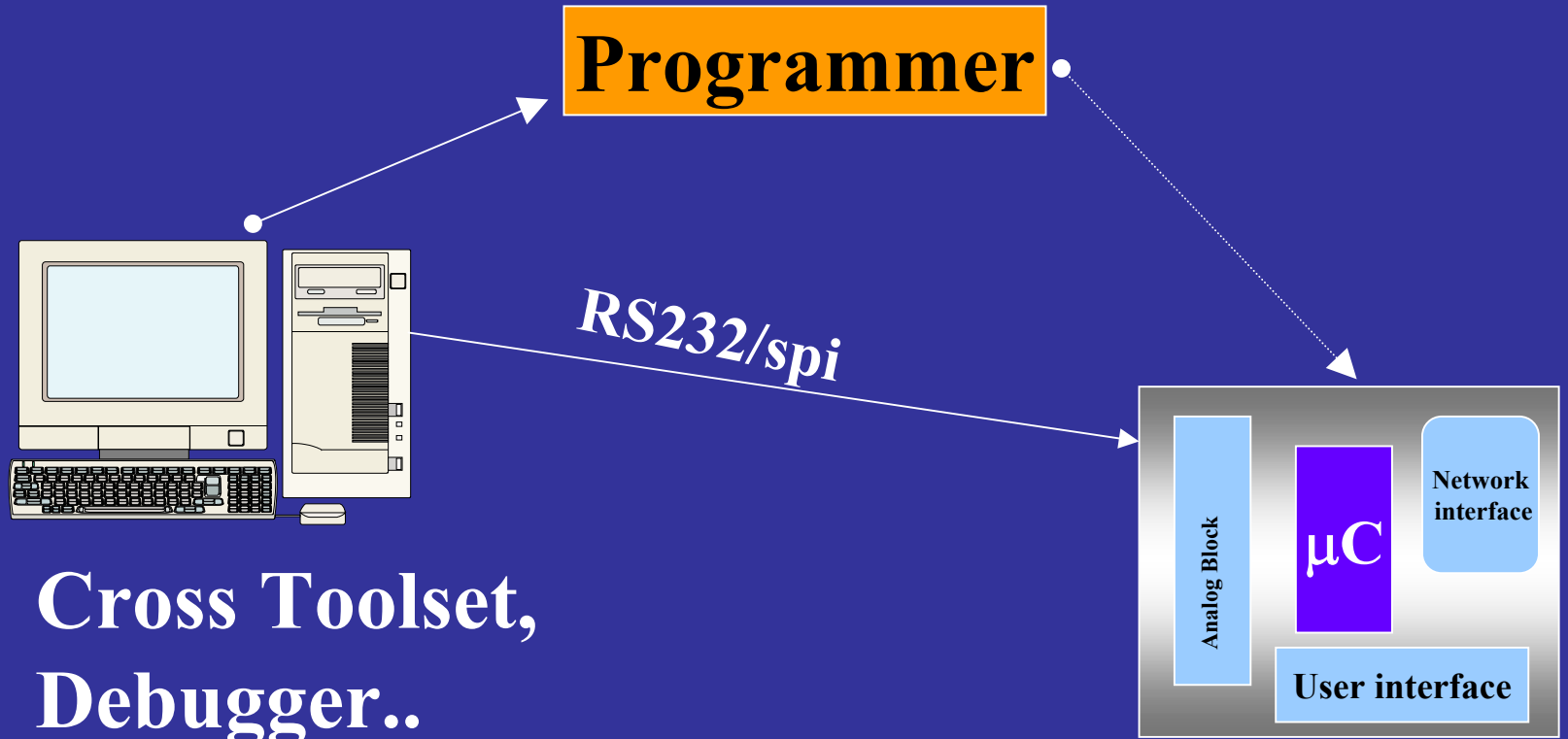
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Embedded System

Your projects' possible look:



Programming



Cross Toolset,
Debugger..

Target brd.

Modulewise Assembly and testing!

- Microcontroller chip should be first
 - Check for PCB errors BEFORE starting soldering!
 - make small test program like blinking led
 - then get the UI running
- Soldering next-module Precautions
 - remove mcu from socket to avoid damage, (static etc..)

Debugging

- **Power Supply ON PINS**
- **Check Heartbeat ! (ALE) for 805x
(square wave)**
- **Write Many Test Programs**
 - **Blink**
 - **Switchboard test**
 - **Serial test**

COMMON ERRORS

- Use **ONLY 33pf** on Crystal
- **PSEN**
- **Crystal is fragile**
- **for 89c2051**
 - **Pwr ON Reset R > 60 K!** (read datasheet)

TIPS

- USE resistor SIP (single inline pack) to PULL UP
- DISABLE ALL UNUSED Interrupts
- Use a 10 μ F cap. across the ADC supply
- Put many Status Indicator LEDs on the board
(helps A LOT in debugging and knowing if your software is working or not)
- disable watchdog timer initially and get the system running
- EACH DIGITAL CHIP SHOULD HAVE A DECOUPLING CAPACITOR near it, accross pwr. supply. (good design practice) [0.1 μ F]